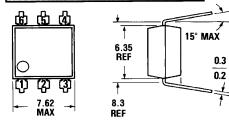
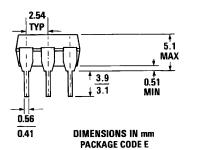
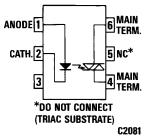


# MOC3020 MOC3021 MOC3022 MOC3023

## **PACKAGE DIMENSIONS**







Equivalent Circuit

### DESCRIPTION

The MOC3020, MOC3021, MOC3022 and MOC3023 are optically isolated triac driver devices. These devices contain a GaAs infrared emitting diode and a light activated silicon bilateral switch, which functions like a triac. This is designed for interfacing between electronic controls and power triacs to control resistive and inductive loads for 240 VAC operations.

## **FEATURES**

- Excellent I<sub>FT</sub> stability—IR emitting diode has low degradation
- High isolation voltage—minimum 7500 VAC peak
   Underwriters Laboratory (UL) recognized—File #E90700

### **APPLICATIONS**

- European applications for 240 VAC
- Triac driver
- Industrial controls
- Traffic lights
- Vending machines
- Motor control
- Solid state relay

ST1603

ABSOLUTE MAXIMUM RATINGS				
TOTAL PACKAGE  Storage temperature	INPUT DIODE           Forward DC current         50 n           Reverse voltage         3           Peak forward current         (1 μs pulse, 300 pps)           Power dissipation (25°C ambient)         100 m           Derate linearly (above 25°C ambient)         1.33 mW/			
	OUTPUT DRIVEROff-state output terminal voltage $400 \text{ Volts}$ On-state RMS current $T_A=25^{\circ}\text{C}$ $100 \text{ mA}$ (Full cycle, 50 to $60 \text{ Hz}$ ) $T_A=70^{\circ}\text{C}$ $50 \text{ mA}$ Peak nonrepetitive surge current $1.2 \text{ A}$ (PW=10 ms, DC=10%) $1.2 \text{ Ns}$ $1.2 \text{ Ns}$ Total power dissipation (25°C ambient) $1.2 \text{ Ns}$ $1.2 \text{ Ns}$ Derate above $1.2 \text{ Cs}$ $1.2 \text{ Ns}$ $1.2 \text{ Ns}$			



# **ELECTRO-OPTICAL CHARACTERISTICS** (25°C Temperature Unless Otherwise Specified)

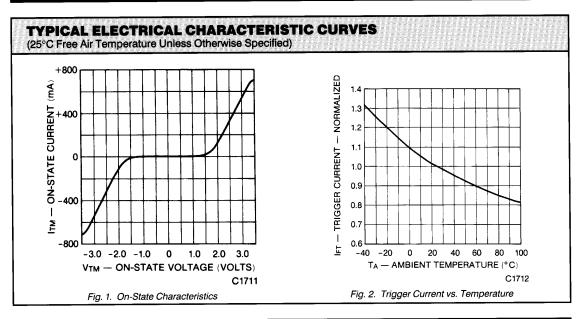
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
INPUT DIODE Forward voltage	$V_{\scriptscriptstyle F}$		1.2	1.50	V	I <sub>F</sub> =10 mA
Junction capacitance	C,	-	50		pF	V <sub>F</sub> =0 V, f=1 MHz
Reverse leakage current	I <sub>R</sub>			100	μΑ	V <sub>R</sub> =3.0 V
OUTPUT DETECTOR Peak blocking current, either direction	I <sub>DHM</sub>	_	10	100	nA	V <sub>DRM</sub> =400 V, Note 1
Peak on-state voltage, either direction	V <sub>TM</sub>	_	2.5	3.0	Volts	I <sub>™</sub> =100 mA Peak

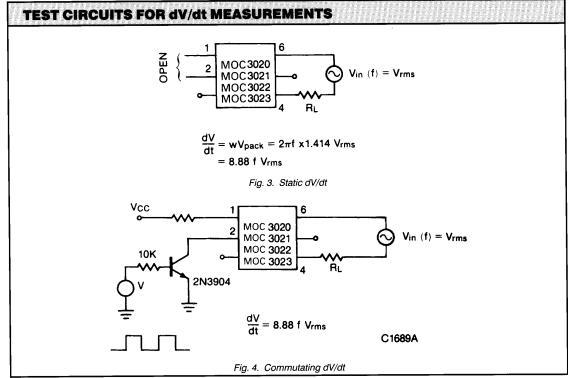
DC CHARACTER	ISTICS	SYMBOL	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
LED trigger current (current required MOC3020	l <sub>FT</sub> —	_	_	30	mA	Main terminal	
MOC30	MOC3021	I <sub>FT</sub>		_	15	mA	voltage=3.0 V, R <sub>L</sub> =150Ω
	MOC3022	I <sub>FT</sub>	_	_	10	mA	_
	MOC3023	I <sub>FT</sub>	_	_	5	mA	
Holding current		I <sub>H</sub>	_	100	_	μΑ	Either direction

CHARACTERISTICS	SYMBOL	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
dv/dt RATING Critical rate of rise of off-state voltage	dv/dt	_	12	_	V/μs	Static dv/dt, T <sub>A</sub> =85°C (see Fig. 3)
Critical rate of rise of commutating voltage	dv/dt	_	0.2	_	V/μs	Commutating dv/dt I <sub>LOAD</sub> =15 mA (see Fig. 4)

ISOLATION CHA	RACTERIS	STICS				
CHARACTERISTICS	SYMBOL	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
Isolation voltage	V <sub>iso</sub>	5300			V <sub>AC</sub> RMS	I <sub>ι-0</sub> ≤1 μA, 1 Minute
	V <sub>iso</sub>	7500		-	V <sub>AC</sub> PEAK	l <sub>i-0</sub> ≤ 1 μA, 1 Minute
Isolation resistance	R <sub>iso</sub>	1011			ohms	V <sub>I-O</sub> =500 VDC
Isolation capacitance	C <sub>iso</sub>		0.5		pF	f=1 MHz

Note 1: Ratings apply to either polarity of pin 6 — referenced to pin 4. Voltages must be applied within dv/dt rating.







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